

# HFA06TB120SPbF.. Series

#### HEXFRED™

#### **Features**

- Ultrafast Recovery
- Ultrasoft Recovery
- Very Low I<sub>RRM</sub>
- Very Low Q<sub>rr</sub>
- · Specified at Operating Conditions
- · Lead-Free

#### **Benefits**

- Reduced RFI and FMI
- · Reduced Power Loss in Diode and Switching Transistor
- · Higher Frequency Operation
- · Reduced Snubbing
- · Reduced Parts Count

# (K) BASE

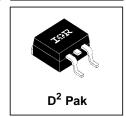
|з <sub>(А)</sub>

(N/C) 1



V<sub>R</sub> = 1200V  $V_F(typ.)^* = 2.4V$  $I_{F(AV)} = 6.0A$ Q<sub>rr</sub> (typ.)= 116nC  $I_{RRM}(typ.) = 4.4A$  $t_{rr}(typ.) = 26ns$  $di_{(rec)M}/dt$  (typ.)\* = 100A/µs

Ultrafast, Soft Recovery Diode



#### Description

International Rectifier's HFA06TB120S is a state of the art ultra fast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 1200 volts and 6 amps continuous current, the HFA06TB120S is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultra fast recovery time, the HEXFRED product line features extremely low values of peak recovery current (I<sub>RRM</sub>) and does not exhibit any tendency to "snap-off" during the tb portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED HFA06TB120S is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

### **Absolute Maximum Ratings**

	Parameter	Max.	Units	
V <sub>R</sub>	Cathode-to-Anode Voltage	1200	V	
I <sub>F</sub> @ T <sub>C</sub> = 100°C	Continuous Forward Current	8.0		
I <sub>FSM</sub>	Single Pulse Forward Current	80	A	
I <sub>FRM</sub>	Maximum Repetitive Forward Current	24	1	
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Maximum Power Dissipation	62.5	10/	
P <sub>D</sub> @ T <sub>C</sub> = 100°C	Maximum Power Dissipation	25	W	
TJ	Operating Junction and	-55 to +150		
T <sub>STG</sub>	Storage Temperature Range	-33 to +130	°C	

\* 125°C

## Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Test Conditions
V <sub>BR</sub>	Cathode Anode Breakdown	1200			V	I <sub>R</sub> = 100μA
	Voltage					
V <sub>FM</sub>	Max. Forward Voltage		2.7	3.0		I <sub>F</sub> = 6.0A
			3.5	3.9	V	I <sub>F</sub> = 12A
			2.4	2.8		I <sub>F</sub> = 6.0A, T <sub>J</sub> = 125°C
I <sub>RM</sub>	Max. Reverse Leakage Current		0.26	5.0		V <sub>R</sub> = V <sub>R</sub> Rated
			110	500	μA	$T_J = 125^{\circ}C$ , $V_R = 0.8 \times V_R$ Rated
Ст	Junction Capacitance		9.0	14	pF	V <sub>R</sub> = 200V
Ls	Series Inductance	_	8.0		nΗ	Measured lead to lead 5mm from pkg body

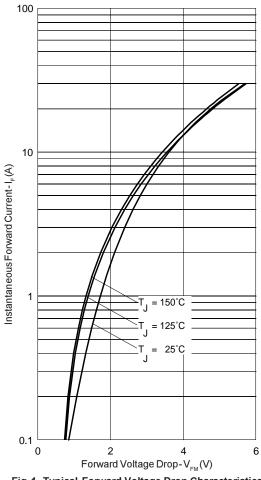
## Dynamic Recovery Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

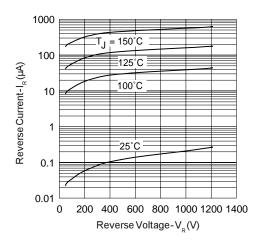
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	Parameter	Min.	Тур.	Max.	Units	Test Con	ditions
t <sub>rr</sub>	Reverse Recovery Time		26			$I_F = 1.0A$ , $di_f/dt = 200A/\mu s$ , $V_R = 30V$	
t <sub>rr1</sub>			53	80	ns	T <sub>J</sub> = 25°C	
t <sub>rr2</sub>			87	130		T <sub>J</sub> = 125°C	I <sub>F</sub> = 6.0A
I <sub>RRM1</sub>	Peak Recovery Current		4.4	8.0	Α	T <sub>J</sub> = 25°C	
I <sub>RRM2</sub>			5.0	9.0		T <sub>J</sub> = 125°C	V <sub>R</sub> = 200V
Q <sub>rr1</sub>	Reverse Recovery Charge		116	320		T <sub>J</sub> = 25°C	
Q <sub>rr2</sub>			233	585	nC	T <sub>J</sub> = 125°C	di <sub>f</sub> /dt = 200A/µs
di <sub>(rec)M</sub> /dt1	Peak Rate of Recovery		180			T <sub>J</sub> = 25°C	
di <sub>(rec)M</sub> /dt2	Current During t <sub>b</sub>		100		A/µs	T <sub>J</sub> = 125°C	

### Thermal - Mechanical Characteristics

	Parameter	Min.	Тур.	Max.	Units
T <sub>lead ①</sub>	Lead Temperature			300	°C
R <sub>thJC</sub>	Thermal Resistance, Junction to Case			2.0	
R <sub>thJA</sub> ②	Thermal Resistance, Junction to Ambient			80	K/W
R <sub>thCS③</sub>	Thermal Resistance, Case to Heat Sink		0.5		
VVt	Weight		2.0		g
			0.07		(oz)

 <sup>0.063</sup> in. from Case (1.6mm) for 10 sec
Typical Socket Mount





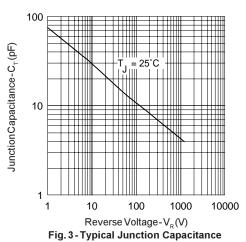


Fig. 1-Typical Forward Voltage Drop Characteristics

Vs. Reverse Voltage

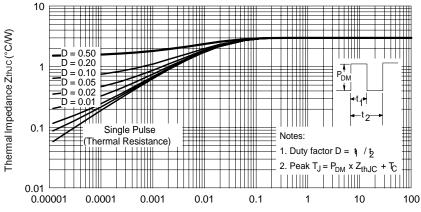
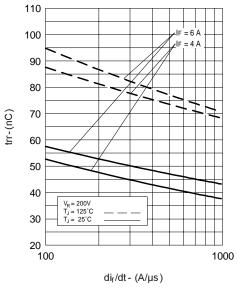


Fig. 4-Maximum Thermal Impedance ZthJC Characteristics



 $\begin{array}{c} \text{Fig. 5-Typical Reverse Recovery} \\ \text{Vs. di}_{\text{f}}/\text{dt} \end{array}$ 

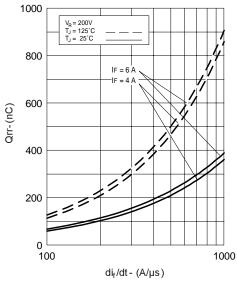


Fig. 8 - Typical Stored Charge vs.  $di_f/dt$ 

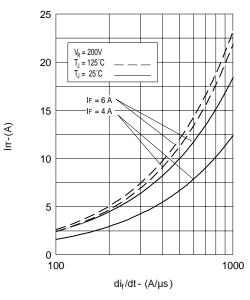
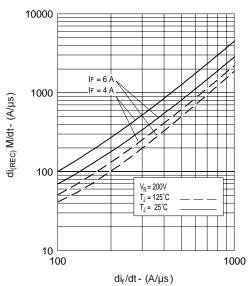


Fig.6-Typical Recovery Current Vs. di<sub>f</sub>/dt



 $Fig.\,7\,\text{-}Typical\ di_{(REC)}\,\text{M/dt}\,\,\text{vs.}\,di_f/dt$ 



## REVERSE RECOVERY CIRCUIT

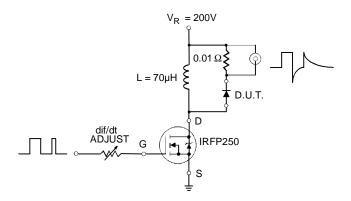
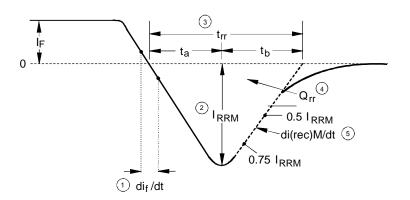


Fig. 9- Reverse Recovery Parameter Test Circuit



1. di/dt - Rate of change of current through zero crossing

2. I<sub>RRM</sub> - Peak reverse recovery current

3. trr - Reverse recovery time measured from zero crossing point of negative going I<sub>F</sub> to point where a line passing through 0.75 I<sub>RRM</sub> and 0.50 I<sub>RRM</sub> extrapolated to zero current 1.  $Q_{rr}$  - Area under curve defined by  $t_{rr}$  and  $l_{\mathsf{RRM}}$ 

 $Q_{rr} = \frac{t_{rr} X I_{RRM}}{2}$ 

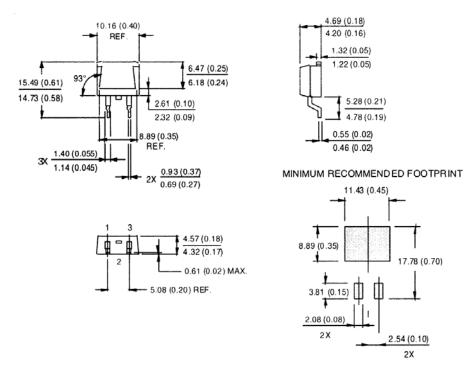
5.  $di_{\text{(rec)M}}/dt$  - Peak rate of change of current during  $t_b$  portion of  $t_{\text{rr}}$ 

Fig. 10 - Reverse Recovery Waveform and Definitions

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## D<sup>2</sup>PAK Package Outline

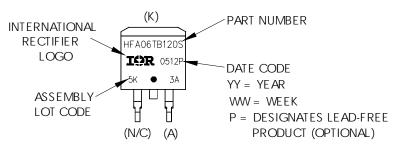
Dimensions are shown in millimeters (inches)



Conforms to JEDEC Outline D<sup>2</sup>PAK Dimensions in millimeters and inches

# D<sup>2</sup>PAK Part Marking Information

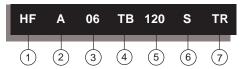
EXAMPLE: THIS IS A HFA06TB120S





### **Ordering Information Table**

#### **Device Code**



1 Hexfred Family

2 Process Designator

A = A subs. elec. irrad.

B = B subs. Platinum

3 Average Current: Code 06 = 6 AMPS

4 Package Outline: Code TB = TO-220 2 Lead

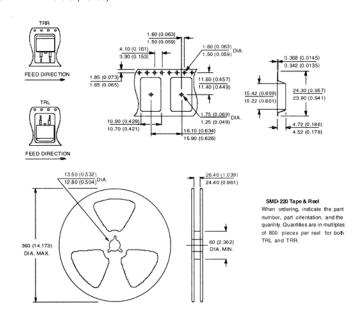
5 Voltage code: Code 120 = 1200 V

Configuration: Code S = SMD

Suffix: Code TR = Tape and Reel

## D<sup>2</sup>PAK Tape & Reel Information

Dimensions are shown in millimeters (inches)



Data and specifications subject to change without notice. This product has been designed and qualified for the Consumer market. Qualifications Standards can be found on IR's Web site.



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